

December 1995

Features

- 70A, 60V
- $r_{DS(on)} = 0.014\Omega$
- *Temperature Compensated PSPICE Model*
- *Peak Current vs Pulse Width Curve*
- *UIS Rating Curve (Single Pulse)*
- +175°C Operating Temperature

Description

The RFG70N06, RFP70N06, RF1S70N06 and RF1S70N06SM are N-channel power MOSFETs manufactured using the MegaFET process. This process, which uses feature sizes approaching those of LSI circuits, gives optimum utilization of silicon, resulting in outstanding performance. They were designed for use in applications such as switching regulators, switching converters, motor drivers and relay drivers. These transistors can be operated directly from integrated circuits.

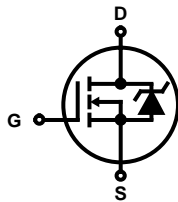
PACKAGE AVAILABILITY

PART NUMBER	PACKAGE	BRAND
RFG70N06	TO-247	RFG70N06
RFP70N06	TO-220AB	RFP70N06
RF1S70N06	TO-262AA	F1S70N06
RF1S70N06SM	TO-263AB	F1S70N06

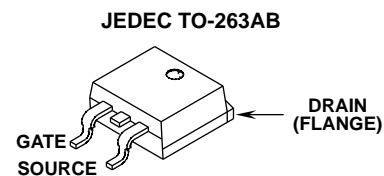
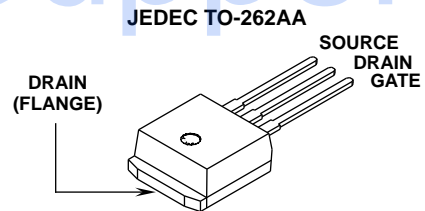
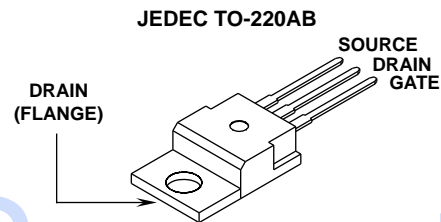
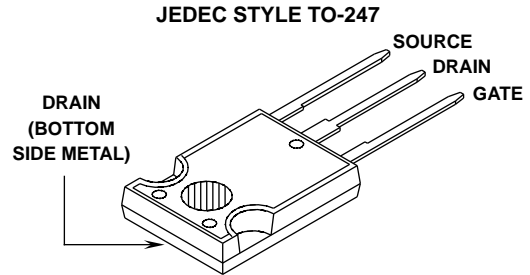
NOTE: When ordering use the entire part number. Add the suffix, 9A, to obtain the TO-263AB variant in tape and reel, e.g. RF1S70N06SM9A.

Formerly developmental type TA49007.

Symbol



Packages



Absolute Maximum Ratings $T_C = +25^\circ\text{C}$, Unless Otherwise Specified

	RFG70N06, RFP70N06 RF1S70N06, RF1S70N06SM	UNITS
Drain Source Voltage	60	V
Drain Gate Voltage	60	V
Gate Source Voltage	± 20	V
Drain Current		
RMS Continuous	70	A
Pulsed Drain Current	Refer to Peak Current Curve	
Single Pulse Avalanche Rating	Refer to UIS Curve	
Power Dissipation		
$T_C = +25^\circ\text{C}$	150	W
Derate above $+25^\circ\text{C}$	1.0	W/ $^\circ\text{C}$
Operating and Storage Temperature	-55 to +175	$^\circ\text{C}$

Specifications RFG70N06, RFP70N06, RF1S70N06, RF1S70N06SM

Electrical Specifications $T_C = +25^\circ\text{C}$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS	
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$	60	-	-	V	
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}$, $I_D = 250\mu\text{A}$	2	-	4	V	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60\text{V}$, $V_{GS} = 0\text{V}$	$T_C = +25^\circ\text{C}$	-	-	1	μA
			$T_C = +150^\circ\text{C}$	-	-	50	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 20\text{V}$	-	-	100	nA	
On Resistance	$r_{DS(ON)}$	$I_D = 70\text{A}$, $V_{GS} = 10\text{V}$	-	-	0.014	Ω	
Turn-On Time	t_{ON}	$V_{DD} = 30\text{V}$, $I_D = 70\text{A}$ $R_L = 0.43\Omega$, $V_{GS} = +10\text{V}$ $R_{GS} = 2.5\Omega$	-	-	125	ns	
Turn-On Delay Time	$t_{D(ON)}$		-	12	-	ns	
Rise Time	t_R		-	50	-	ns	
Turn-Off Delay Time	$t_{D(OFF)}$		-	40	-	ns	
Fall Time	t_F		-	15	-	ns	
Turn-Off Time	t_{OFF}		-	-	125	ns	
Total Gate Charge	$Q_{G(TOT)}$		$V_{GS} = 0\text{V}$ to 20V	$V_{DD} = 48\text{V}$, $I_D = 70\text{A}$, $R_L = 0.68\Omega$	-	185	215
Gate Charge at 10V	$Q_{G(10)}$	$V_{GS} = 0\text{V}$ to 10V	-		100	115	nC
Threshold Gate Charge	$Q_{G(TH)}$	$V_{GS} = 0\text{V}$ to 2V	-		5.5	6.5	nC
Input Capacitance	C_{ISS}	$V_{DS} = 25\text{V}$, $V_{GS} = 0\text{V}$ $f = 1\text{MHz}$	-	3000	-	pF	
Output Capacitance	C_{OSS}		-	900	-	pF	
Reverse Transfer Capacitance	C_{RSS}		-	300	-	pF	
Thermal Resistance Junction to Case	$R_{\theta JC}$		-	-	1.0	$^\circ\text{C/W}$	
Thermal Resistance Junction to Ambient	$R_{\theta JA}$		-	-	80	$^\circ\text{C/W}$	

Source-Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Forward Voltage	V_{SD}	$I_{SD} = 70\text{A}$	-	-	1.5	V
Reverse Recovery Time	t_{RR}	$I_{SD} = 70\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	-	125	ns

Typical Performance Curves

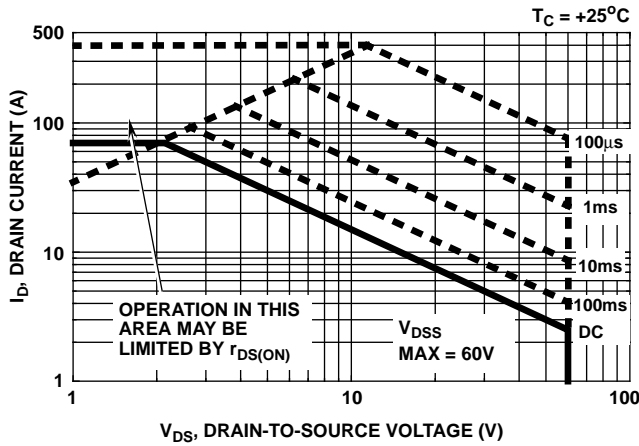


FIGURE 1. SAFE OPERATING AREA CURVE

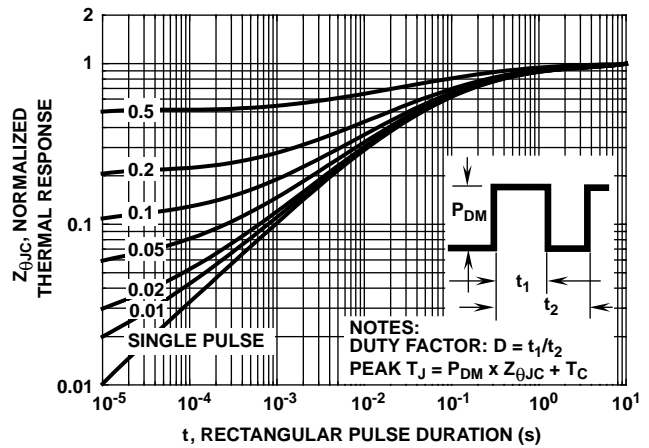


FIGURE 2. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE

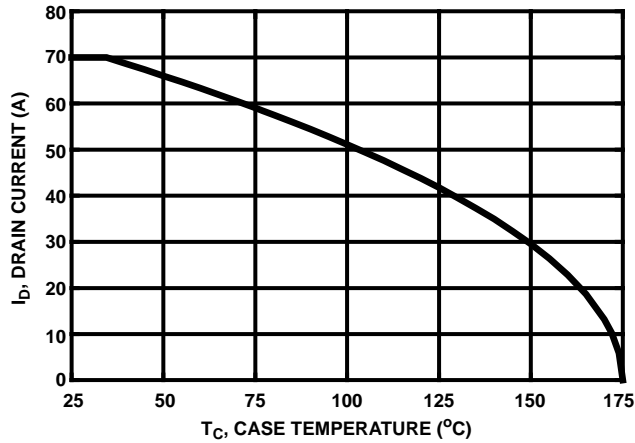


FIGURE 3. MAXIMUM CONTINUOUS DRAIN CURRENT vs TEMPERATURE

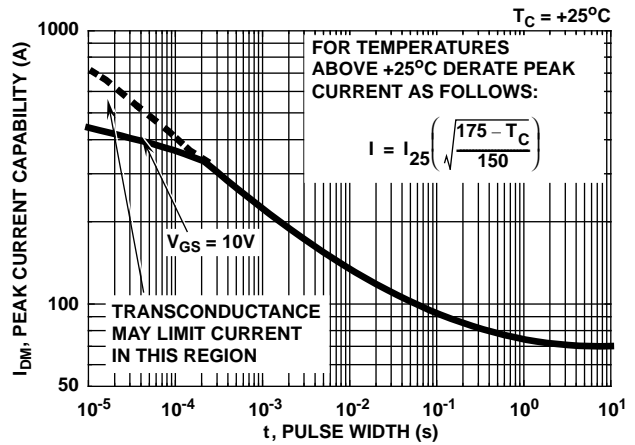


FIGURE 4. PEAK CURRENT CAPABILITY

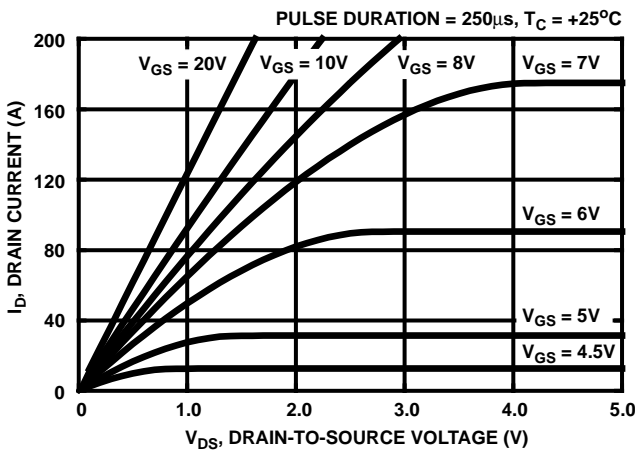


FIGURE 5. TYPICAL SATURATION CHARACTERISTICS

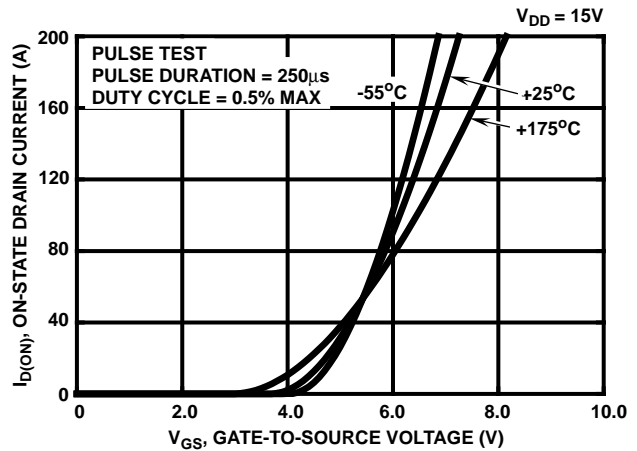


FIGURE 6. TYPICAL TRANSFER CHARACTERISTICS

Typical Performance Curves (Continued)

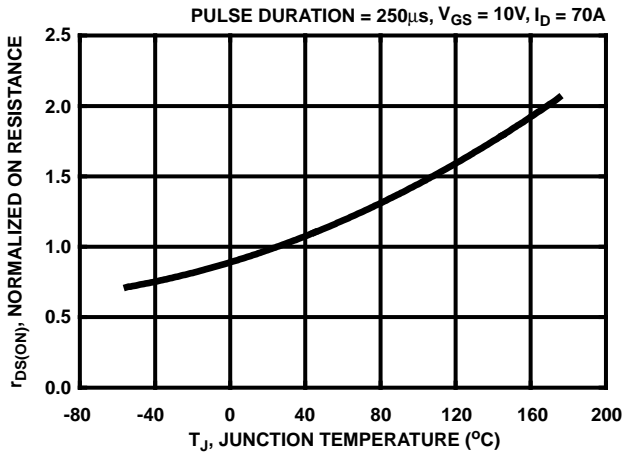


FIGURE 7. NORMALIZED $r_{DS(ON)}$ vs JUNCTION TEMPERATURE

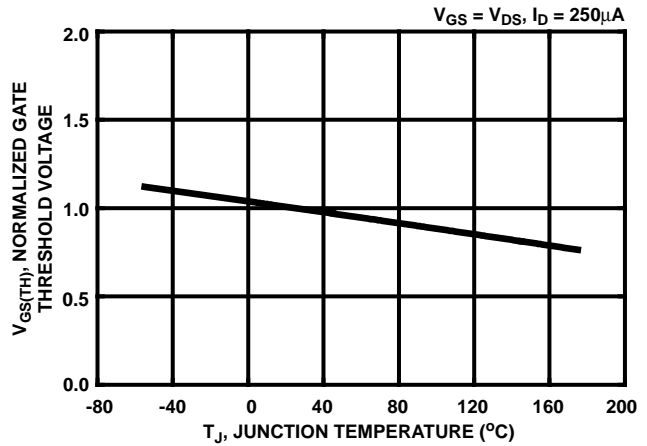


FIGURE 8. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

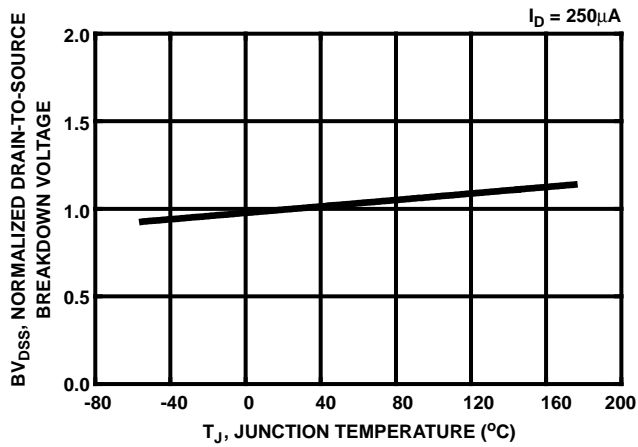


FIGURE 9. NORMALIZED DRAIN-SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

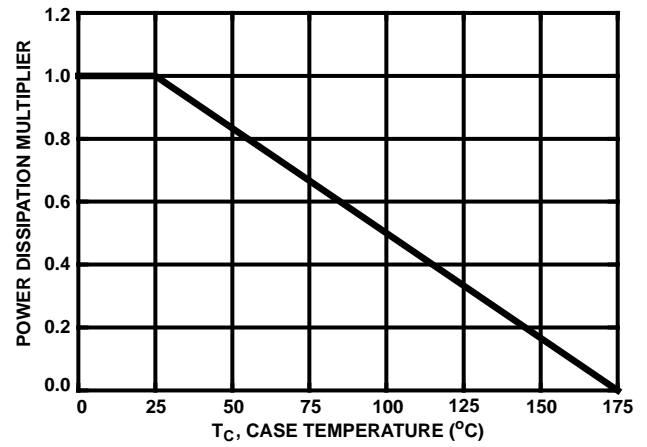


FIGURE 10. NORMALIZED POWER DISSIPATION vs TEMPERATURE DERATING CURVE

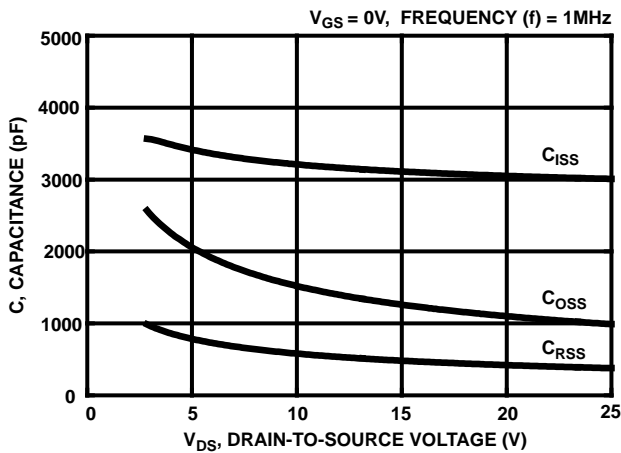


FIGURE 11. TYPICAL CAPACITANCE vs VOLTAGE

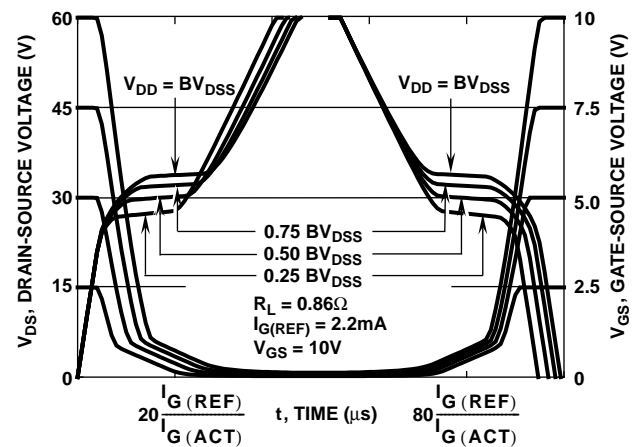


FIGURE 12. NORMALIZED SWITCHING WAVEFORMS FOR CONSTANT GATE CURRENT. REFER TO HARRIS APPLICATION NOTES AN7254 AND AN7260

Typical Performance Curves (Continued)

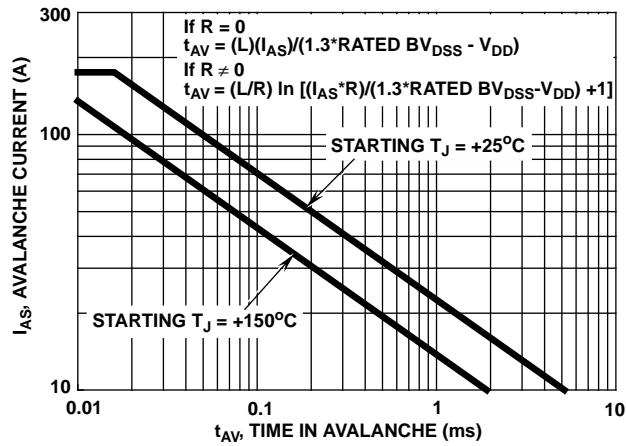


FIGURE 13. UNCLAMPED INDUCTIVE SWITCHING

REFER TO HARRIS APPLICATION NOTES AN9321 AND AN9322

Test Circuits and Waveforms

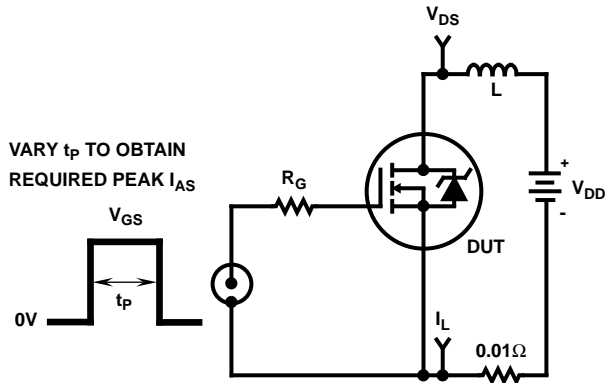


FIGURE 14. UNCLAMPED ENERGY TEST CIRCUIT

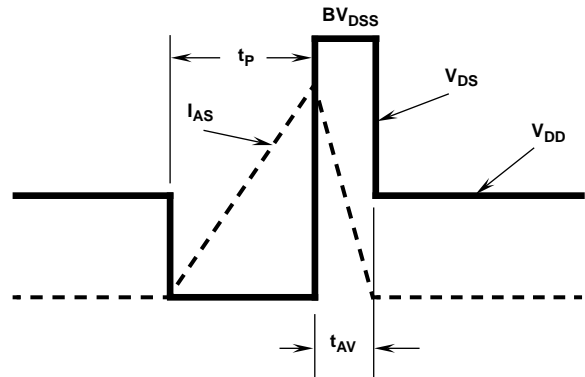


FIGURE 15. UNCLAMPED ENERGY WAVEFORMS

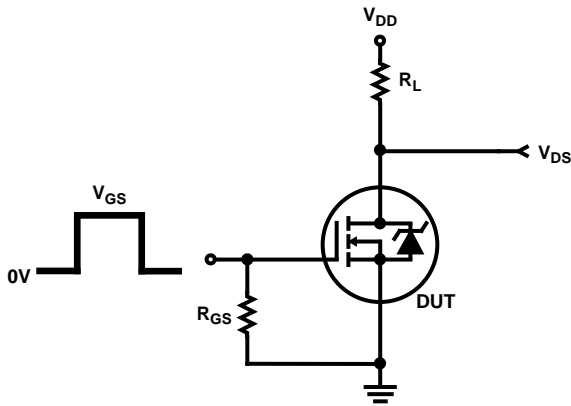


FIGURE 16. RESISTIVE SWITCHING TEST CIRCUIT

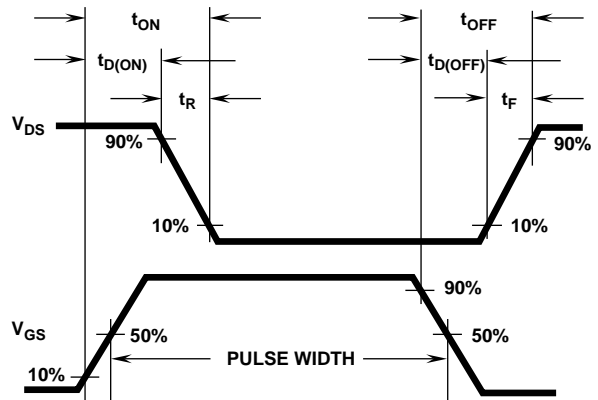


FIGURE 17. RESISTIVE SWITCHING WAVEFORMS

